2017 Fall

"Phase Transformation in Materials"

11.13.2017

Eun Soo Park

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Office: 33-313 Telephone: 880-7221 Email: espark@snu.ac.kr Office hours: by an appointment **Chapter 3 Crystal Interfaces and Microstructure**

- 1) Interfacial Free Energy
- 2) Solid/Vapor Interfaces
- 3) Boundaries in Single-Phase Solids
- 4) Interphase Interfaces in Solid (α/β)
- 5) Interface migration

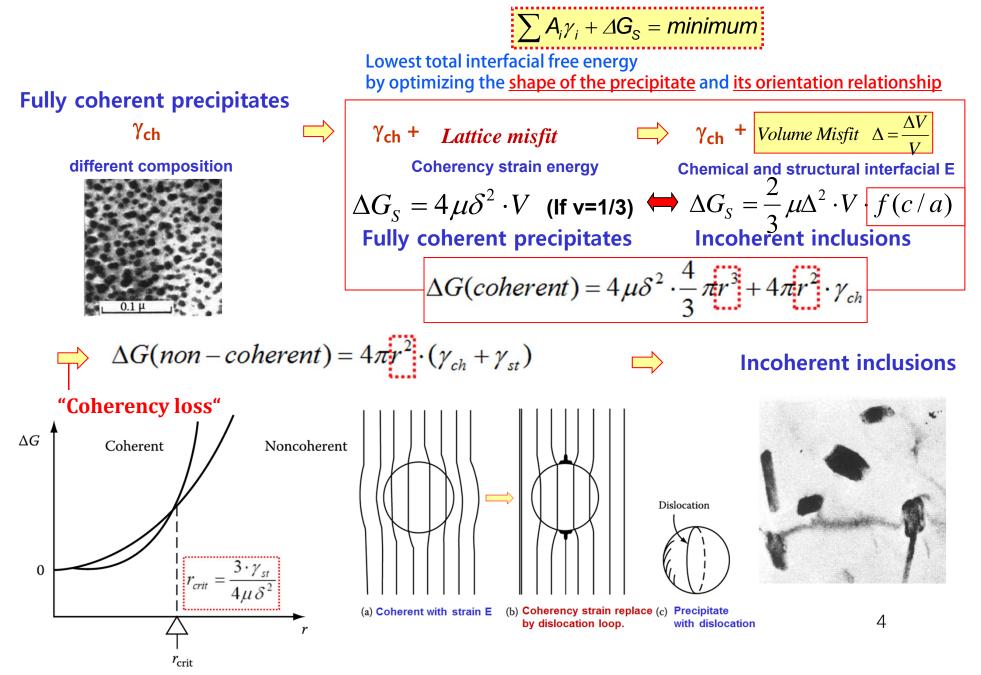
Contents for previous class

3.4 Interphase Interfaces in Solids

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Interphase boundary - different two phases : different crystal structure different composition
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Perfect atomic matching at interface
coherent.
                      \gamma (coherent) = \gamma_{ch} \gamma (coherent) ~ 200 mJM<sup>-2</sup>
                                                                          semi D \downarrow \rightarrow Strain field overlap
semicoherent \gamma(semicoherent) = \gamma_{ch} + \gamma_{st}
                                                                                      \rightarrow cancel out
                                                                 γ
                        \gamma_{st} \rightarrow due to <u>structural distortions</u>
                        caused by the misfit dislocations
                      \gamma(semicoherent) ~ 200~500 mJM<sup>-2</sup>
                                                                                           δ
                                                                           0.25
                                                                     \delta=4: 1 dislocation per 4 lattices
incoherent
                     1) \delta > 0.25 No possibility of good matching across the interface
                     2) different crystal structure (in general)
                     \gamma (incoherent) ~ 500~1000 mJM<sup>-2</sup>
 Complex Semicoherent Interfaces
  Nishiyama-Wasserman (N-W) Relationship
                                                      Kurdjumov-Sachs (K-S) Relationships
                                                                                                           З
  (The only difference between these two is a rotation in the closest-packed planes of 5.26°.)
  The degree of coherency can, however, be greatly increased if a macroscopically irrational interface is formed.
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3.4 Interphase Interfaces in Solids



3.5. Interface Migration

Phase transformation = Interface creation & Migration

Heterogeneous Transformation (general): parent and product phases during trans.

Nucleation (interface creation) + Growth (interface migration) Nucleation barrier Ex. Precipitation

- at certain sites within metastable alpha phase \rightarrow new beta phase = Nucleation

- <u>most of transformation product</u> is formed during the growth stage by the transfer of atoms across the moving parent/product interface.

- Homogeneous Transformation: PT occurs homogeneously throughout the parent phase.

Growth-interface control

No Nucleation barrier Ex. Spinodal decomposition (Chapter 5)

Order-disorder transformation

* Types of Interface

____ Types of transformation

- Glissile Interface: Athermal, Shape change ----- Military transformation Dislocation gliding

- Non-Glissile Interface: Thermal,
- → Civilian transformation

Random jump of individual atoms: extremely sensitive to temp. ~ similar way to the migration of a random high angle GB

Classification of Heterogeneous (Nucleation and Growth) Transformation

Туре	Military	Civilian			
Effect of temperature change	Athermal	Thermally activated			
Interface type	Glissile (coherent or semicoherent)	Nonglissile (coherent, semicoherent. Incoherent, solid/liquid, or solid/vapor)			
Composition of parent and product phase	Same composition	Same composition	Different compositions		
Nature of diffusion process	No diffusion	Short-range diffusion (across interface)	Long-range diffusion (through lattice)		
Interface, diffusion or mixed control?	Interface control	✓ Interface control	Mainly interface control	Mainly diffusion control	Mixed control
Examples	Martensite twining	Massive ordering	Precipitation dissolution	Precipitation dissolution	Precipitation dissolution
	Symmetric tilt boundary	Polymorphic recrystallization	Bainite condensation	Soldification and melting	Eutectoid
	6500	Grain growth	Evaporation		Cellular precipitation
		Condensation			
		Evaporation			

Source: Adapted from Christian, J.W., in Phase Transformations, Vol. 1, Institute of Metallurgists, 1979, p. 1.

exception) bainite transformation: thermally activated growth/ shape change similar to that product by the motion of a glissile interface

(need to additional research)

Q: What is the structure of interface between liquids and crystals?

Interphase Interfaces in Solid (α/β)

2) Solid /Liquid Interfaces: consequences for the structure and energy of the interface

Faceted interface Rather narrow transition zone approximately one atom layer thick ~ same as solid/vapor interfaces, i.e., atomically flat close-packed interface

: some intermetallic compounds, elements such as Si, Ge, Sb, and most nonmetals

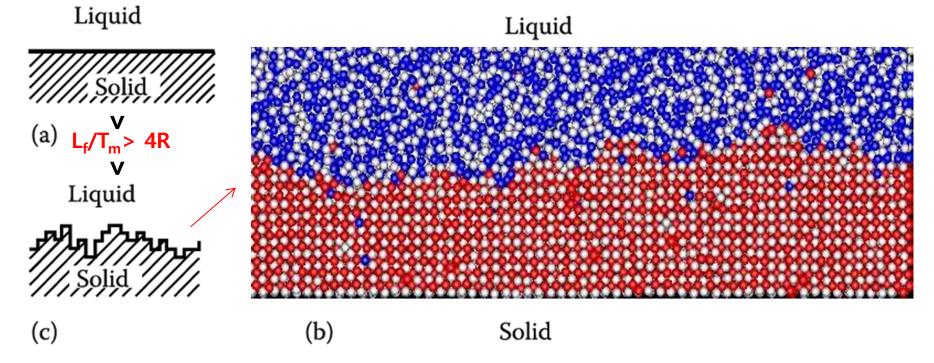
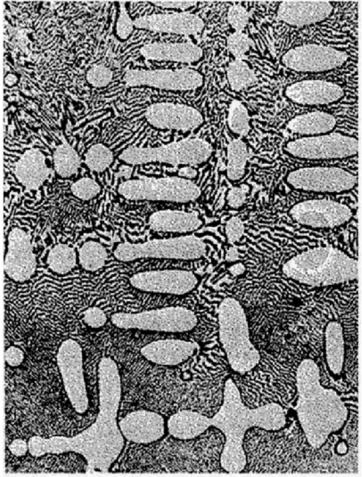


Fig. 3. 63 Solid/liquid interfaces: (a) atomically smooth, (b) and (c) atomically rough, or diffuse interfaces.

Diffusion interface (non-faceted) Rather wide transition zone over several atom layers : most metals, L_f/T_m ~ R (gas constant)~automatically rough & diffuse interface

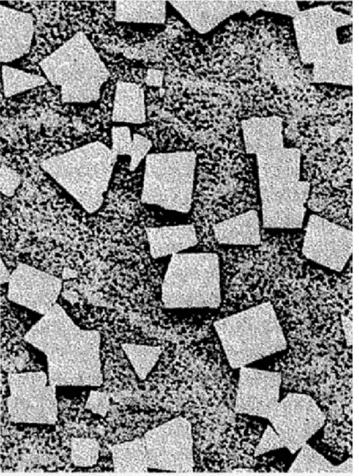
Primary Ag dendrite in Cu-Ag eutectic matrix



(a) Non-faceted

- Free E ~do not vary with crystallographic orientation
- γ-plot ~ spherical

β'-SnSb intermetallic compound in Sn(Sb) solid solution

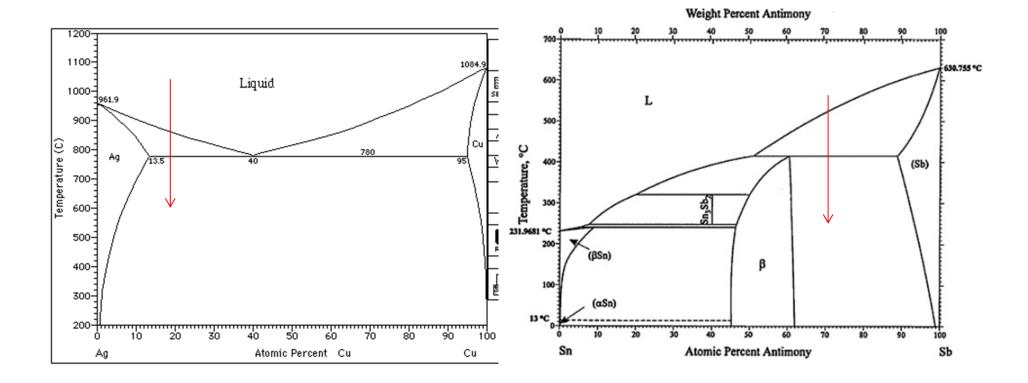


(b) Faceted

- Strong crystallographic effects
- Solidify with low-index close-packed facets

Primary Ag dendrite in Cu-Ag eutectic matrix

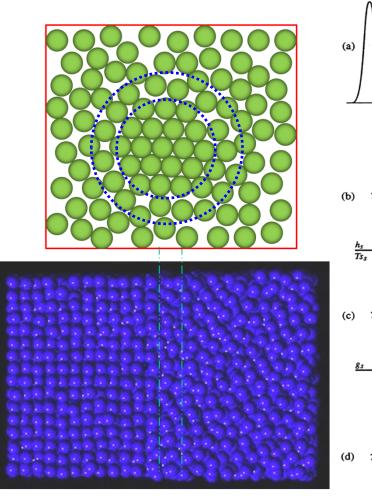
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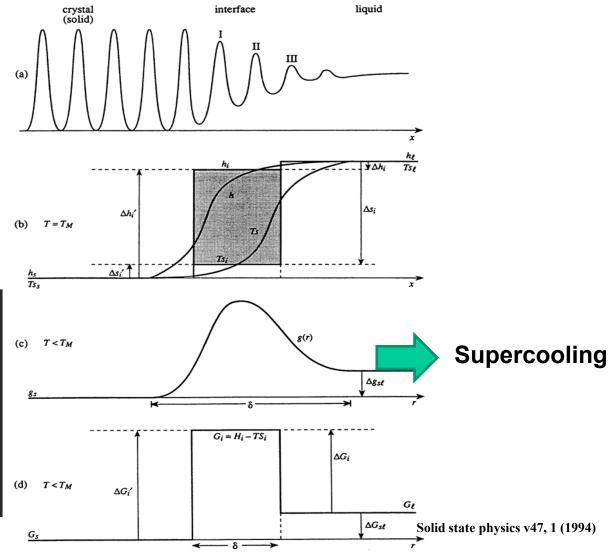


What is the structure of interface between liquids and crystals?

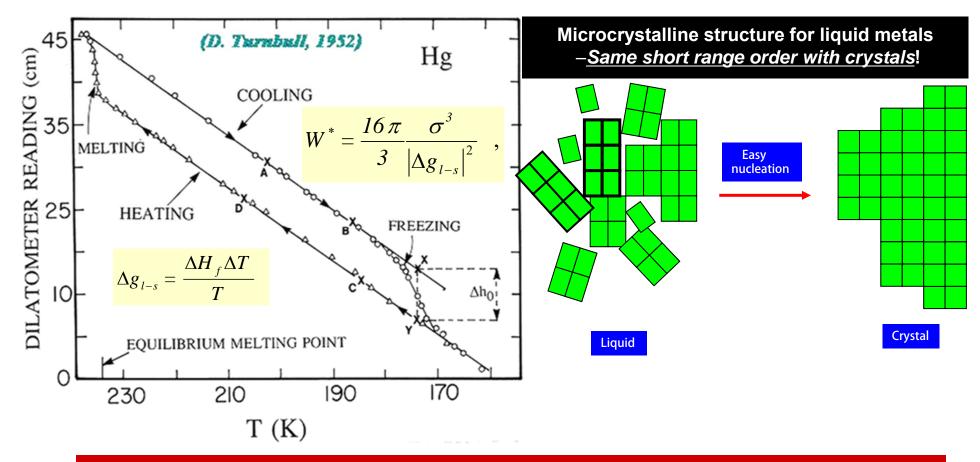
Turnbull's solid-liquid interface

<u>Turnbull's insight:</u> Liquid orders substantially near a crystal surface due to entropy decreasing caused by the crystal-melt interfacial tension





Turnbull's Insight for Supercooling



How does the liquid metals resist on the crystallization?
 What the origin of high nucleation barrier against the crystallization?

* Broken bond model \rightarrow calculation of the E of solid/ liquid interface

 $0.5L_f / N_a \rightarrow 0.45L_f / N_a$ (엔트로피 효과로 감소)

 Table 3.1.
 Relationship between Maximum Supercooling,

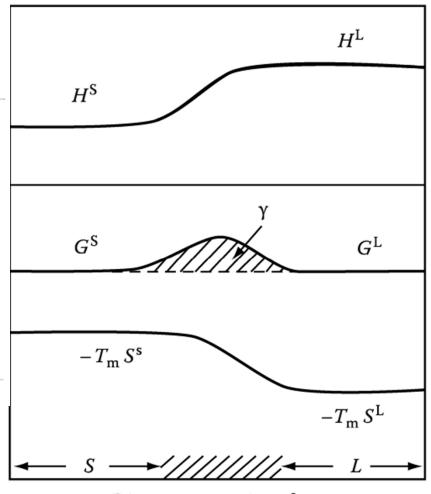
 Solid-Liquid Interfacial Energy and Heat of Fusion^a

	Interfacial			ΔT_{MAX}
Metal	Energy σ (ergs/cm ²)	σ_g (cal/mole)	σ_g/L	ΔI_{MAX} (deg)
Mercury	24.4	296	0.53	77
Gallium	55.9	581	0.44	76
Tin	54.5	720	0.42	118
Bismuth	54.4	825	0.33	90
Lead	33.3	479	0.39	80
Antimony	101	1430	0.30	135
Germanium	181	2120	0.35	227
Silver	126	1240	0.46	227
Gold	132	1320	0.44	230
Copper	177	1360	0.44	236
Manganese	206	1660	0.48	308
Nickel	255	1860	0.44	319
Cobalt	234	1800	0.49	330
Iron	204	1580	0.45	295
Palladium	209	1850	0.45	332
Platinum	240	2140	0.45	370

^a Data from D. Turnbull, J. Appl. Phys., 21, 1022 (1950) and Ref. 3.

 $\gamma_{SL} \approx 0.45 \gamma_{b}$ (= 0.15 γ_{SV}) for the most metals

at equilibrium melting temp.



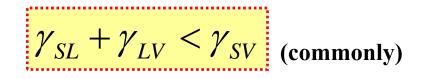
Distance across interface

Showing the origin of the solid/ liquid 13 interfacial energy, γ

4.1.4. Nucleation of melting

Although nucleation during solidification usually requires some undercooling, melting invariably occurs at the equilibrium melting temperature even at relatively high rates of heating.

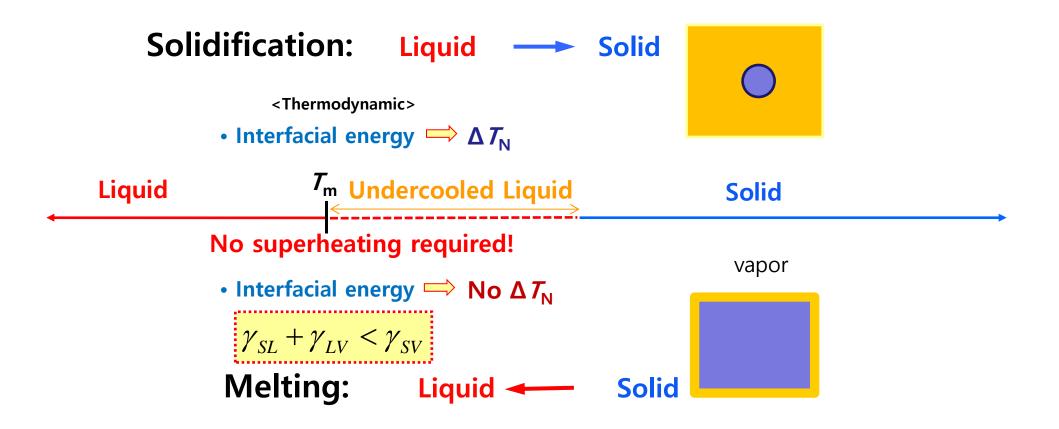
Why?





In general, wetting angle = 0 > No superheating required!

Melting and Crystallization are Thermodynamic Transitions



Q: What is the role of interface migration on phase transformation ?

Interface controlled growth 🗁 Diffusion controlled growth

3.5. Interface Migration

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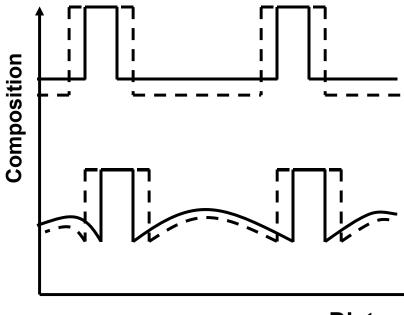
Source: Adapted from Christian, J.W., in Phase Transformations, Vol. 1, Institute of Metallurgists, 1979, p. 1.

exception) bainite transformation: thermally activated growth/ shape change similar to that product by the motion of a glissile interface

(need to additional research)

3.5. Interface Migration

* Civilian Transformation



Distance



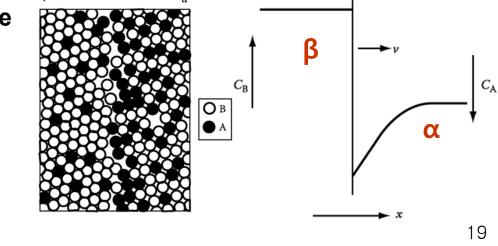
Same composition between parent and product (Ex. $\alpha \rightarrow \gamma$ transformation in pure iron)

The new phase will be able to grow as fast as the atoms can cross the interface. : <u>interfacial reaction velocity dominant</u>

2) Diffusion control

Different composition between parent and product (Ex. The growth of the B-rich phase into the A-rich α-phase)

Growth of the new phase will require long-range diffusion Growth rate: governed by the rate at which lattice diffusion can remove the excess atoms from ahead of the interface.

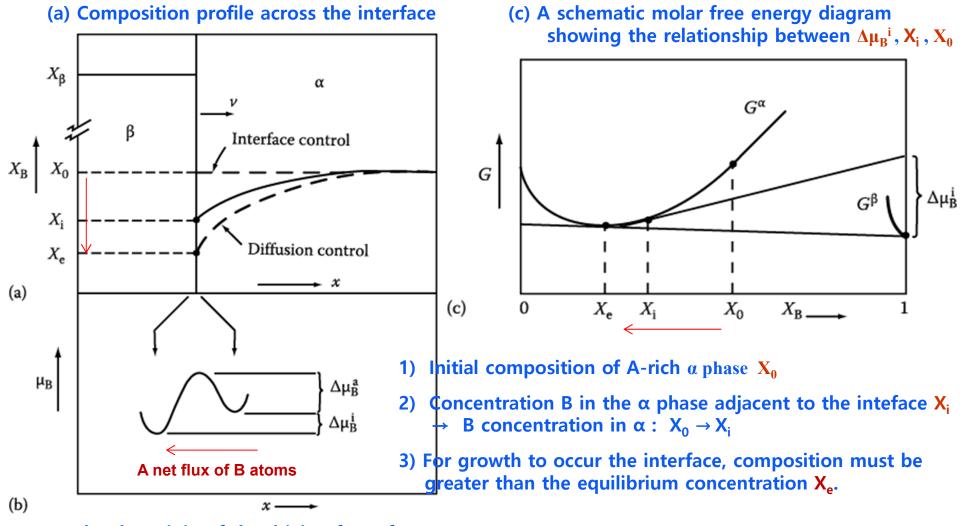


3) Mixed control: interface reaction = diffusion process

3.5.1. Diffusion-Controlled and Interface-Controlled Growth

Fig. 3.67 Interface migration with long-range diffusion

; the migration of interface separating two phases of different composition



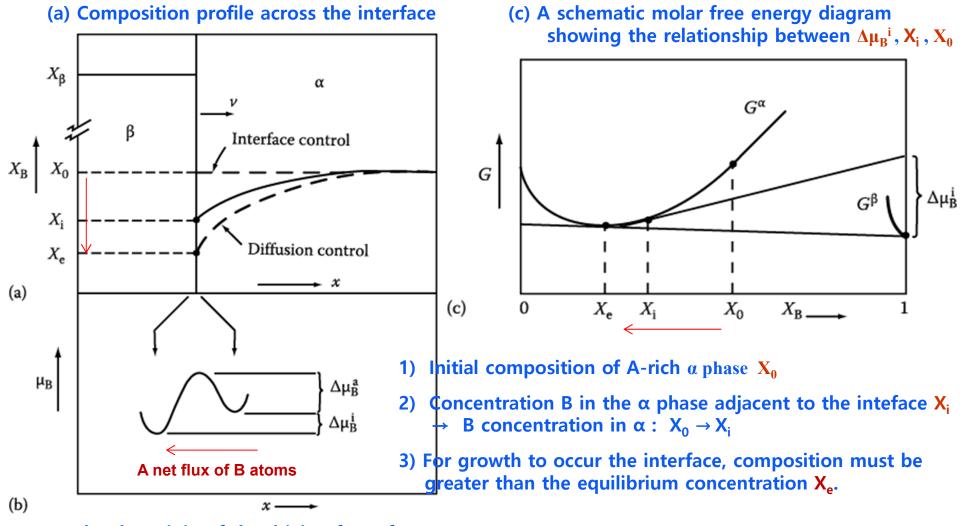
(b) The origin of the driving force for boundary migration into the α -phase $\Delta \mu_{B}{}^{i}$

Total Free Energy Decrease per Mole of Nuclei ΔG_{n} : Driving force for phase transformation of system **Driving Force for Precipitate Nucleation** $\alpha \rightarrow \alpha + \beta$ $\Delta \mathbf{G}_{\mathbf{V}}$ $\Delta G_1 = \mu_A^{\alpha} X_A^{\beta} + \mu_B^{\alpha} X_B^{\beta}$ α : Decrease of total free E of system by removing a small amount of material $\alpha + \beta$ **-** B with the nucleus composition (X_{B}^{β}) (P point) T_2 $\Delta G_2 = \mu_A^\beta X_A^\beta + \mu_B^\beta X_B^\beta$: Increase of total free E of system (a) A Xe X_0 X^{β} by forming β phase with composition X_{R}^{β} $X_{\rm B} \longrightarrow$ B (Q point) $@T_2$ $\Delta G_n = \Delta G_2 - \Delta G_1$ (length PQ) $\mu_{\rm B}^{\alpha}$ G G^{α} G_r^{β} $\Delta G_{V} = \frac{\Delta G_{n}}{V}$ per unit volume of β : driving force for β precipitation ΔG_n dXA For dilute solutions, ΔG_0 IG^β μβ μβ $\Delta G_{V} \propto \Delta X$ where $\Delta X = X_{0} - X_{e}$ ↑ μ^a_A $\Delta G_{V} \propto \Delta X \propto (\Delta T)$ 21 \propto undercooling below T_a (b) 0 $X_{\rm R}$ – 1

3.5.1. Diffusion-Controlled and Interface-Controlled Growth

Fig. 3.67 Interface migration with long-range diffusion

; the migration of interface separating two phases of different composition



(b) The origin of the driving force for boundary migration into the α -phase $\Delta \mu_{B}{}^{i}$

By analogy with the migration of a high-angle GB (section 3.3.4), the net flux B across the interface will produce an interface velocity *v* given by

• (section 3.3.4) Kinetics of grain growth

- Grain boundary migration (v) by thermally activated atomic jump

Boundary velocity $\boldsymbol{v} = \frac{A_2 n_1 v_1 V_m^2}{N_a RT} \exp\left(-\frac{\Delta G^a}{RT}\right) \frac{\Delta G}{V_m} \qquad \qquad \boldsymbol{v} \sim \Delta G/V_m \text{ driving force} \\ \rightarrow F = \Delta G/V_m \\ M : \text{ mobility = velocity under unit driving force } \sim \exp(-1/T)$

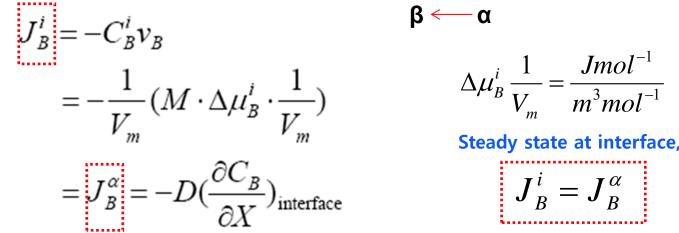
rate of grain growth $d\underline{D}/dt \sim 1/\underline{D}$, exponentially increase with \mathcal{T}

• Interface velocity of precipitate V =

$$v = M \Delta \mu_B^i / V_m$$

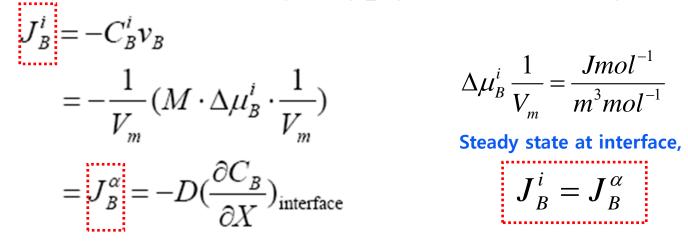
M = interface mobility, V_m = molar volume of the β phase

• Corresponding flux across the interface (negative sign_negative direction of flux along the x-axis)



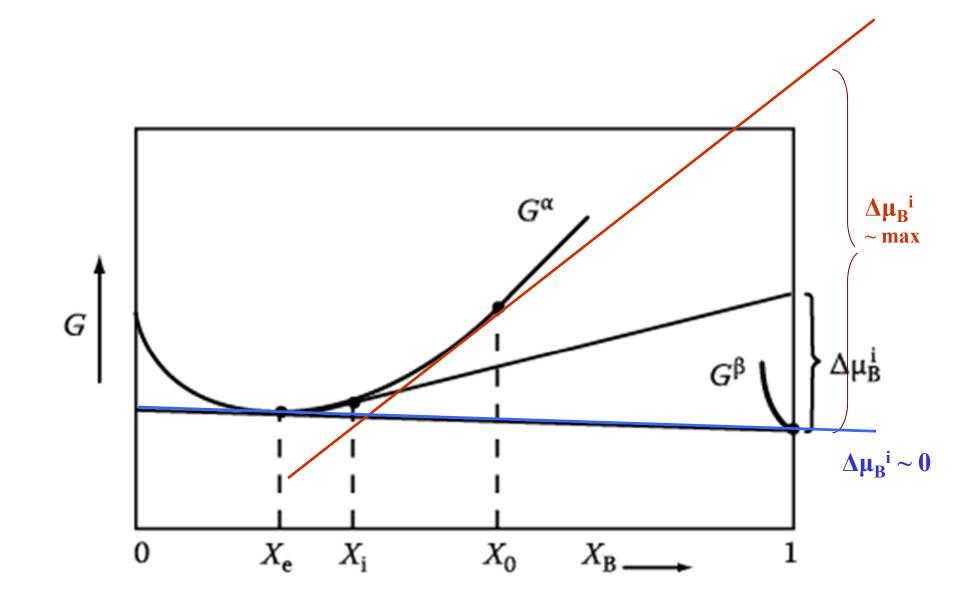
A flux of B atoms toward the interface by the concentration gradient in the α phase

Corresponding flux across the interface (negative sign_negative direction of flux along the x-axis)



A flux of B atoms toward the interface by the concentration gradient in the α phase

1) If the interface mobility is very high, e.g. an incoherent interface, High Mobility: $\Delta \mu_B^i$ small, $X_i \approx X_e$, Diffusion-Control 2) When the interface has a low mobility, Low Mobility: $\Delta \mu_B^i$ must be large Mixed-Control 3) In the limit of a very low mobility, Very low Mobility: $Xi \approx X_o$, $\left(\frac{\partial C}{\partial X}\right)_{intrface} \approx 0$, Interface-Control



When two phases have a different composition,

In general,

the necessary long-range diffusion involves a great many atom jumps while interface reaction essentially involves only one jump.

All interface reactions should be very rapid in comparison to lattice diffusion, i.e., all growth should be diffusion controlled. (next page)

Ex) Diffusion control

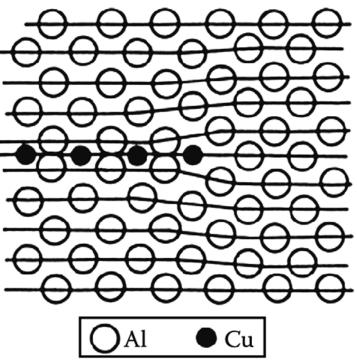
Al-Cu ppt structures

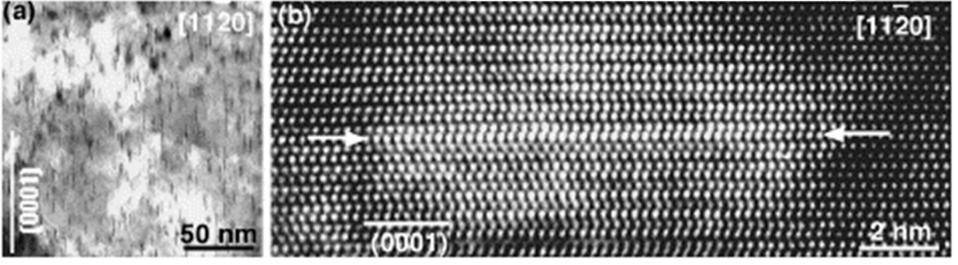
If two phases with different compositions, but the same crystal structure are separated by a coherent interface

Interface can advance by normal lattice diffusion involving vacancies.

No need for a separated interface reaction

Ex) GP zones/ semicoherent interface with misfit dislocation (vacancy creation and annihilation)





(a) Bright-field TEM image showing G.P. zones, and (b) HRTEM image of a G.P. zone formed on a single $(0\ 0\ 1)_{\alpha}$ plane. Electron beam is parallel to in both (a) and (b).

When two phases have a different composition,

In general,

the necessary long-range diffusion involves a great many atom jumps while interface reaction essentially involves only one jump.

All interface reactions should be very rapid in comparison to lattice diffusion, i.e., all growth should be diffusion controlled. (next page)

In many cases ~ valid, but under certain conditions ~ insufficient

Accommodation factor (A_수용인자)

Probability that an atom crossing the boundary will accommodated on arrival at the new phase

Incoherent interfaces and diffuse interface solid/liquid interfaces, as high-angle grain boundaries = value of A close to unity \implies "diffusion control"

Coherent or semicoherent interfaces as well as smooth solid/liquid interfaces = low values of A \implies "Some degree of interface control"

Ex) Interface control

1) When two phases forming a coherent or semicoherent interface have different crystal structures.

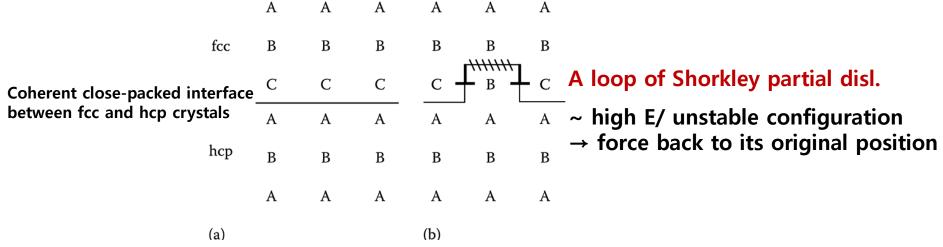
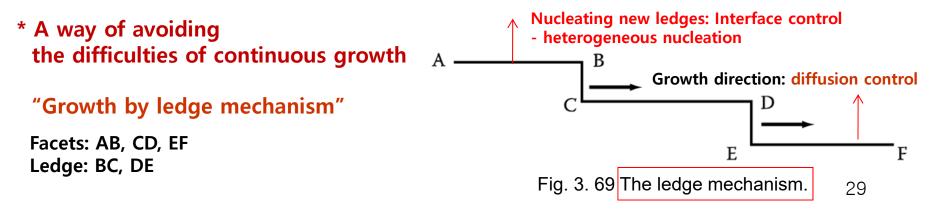


Fig. 3. 68 Problems associated with the continuous growth of coherent interfaces between phases with different crystal structures.

hcp phase growth by individual atomic jumps (i.e., so-called continuous growth) ~ very difficult (very low accommodation factors and low mobility)

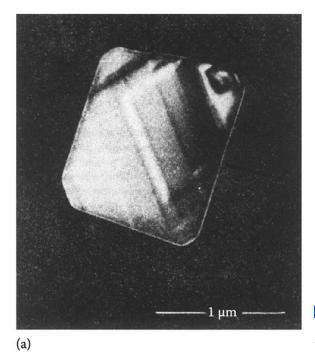
2) Solid/vapor as well as smooth solid/liquid interfaces ~ similar manner

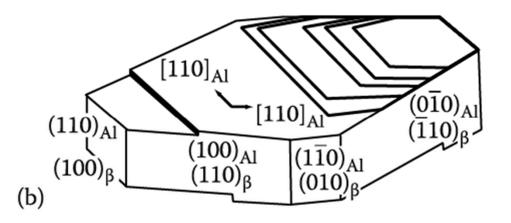


→ Problem of nucleation new ledges may often lead to a degree of interface control on the overall rate.

Fig. 3. 70 (a) Growth ledges at an Mg₂Si plate in Al-1.5 wt% Mg₂Si, solution treated and aged 2h at 350 $^{\circ}$ C. Dark field micrograph.

(b) Schematic diagram of (a) showing ledges on Mg_2Si plate.





Note that growth ledges are usually hundreds of atoms layers high. 성장 돌출맥의 층 두께는 보통 수백 원자층 두께

The <u>mechanism of interface migration</u> can have <u>important effects on</u> <u>the shape of second-phase inclusions.</u> (section 3.4.2)

- if absence of strain E effect, equilibrium shape of a precipitate should be determined by

- a) the relative energies of the bounding interfaces (dominant) *γ*-plot 계면 E의 상대적 비
 - ex) a partially coherent precipitate~disk or plate shape with an aspect ratio of $\gamma i / \gamma c$
- b) (in practice) "relative rates" at which the coherent and incoherent interface can migrate

정합/ 부정합 계면의 상대적인 이동속도 차에 의해 형상 변화

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		Condensation Evaporation			

Source: Adapted from Christian, J.W., in Phase Transformations, Vol. 1, Institute of Metallurgists, 1979, p. 1.

exception) bainite transformation: thermally activated growth/ shape change similar to that product by the motion of a glissile interface

(need to additional research)

* Homework 3 : Exercises 3 (pages 186-188) until 20th November (before class)

Good Luck!!

Contents in Phase Transformation

Background to understand phase transformation

(Ch1) Thermodynamics and Phase Diagrams (Ch2) Diffusion: Kinetics

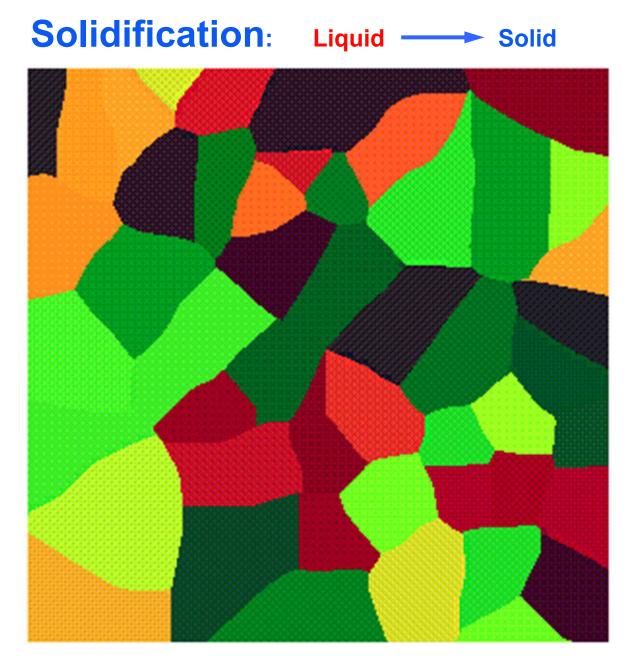
(Ch3) Crystal Interface and Microstructure

(Ch4) Solidification: Liquid \rightarrow Solid

Representative Phase transformation

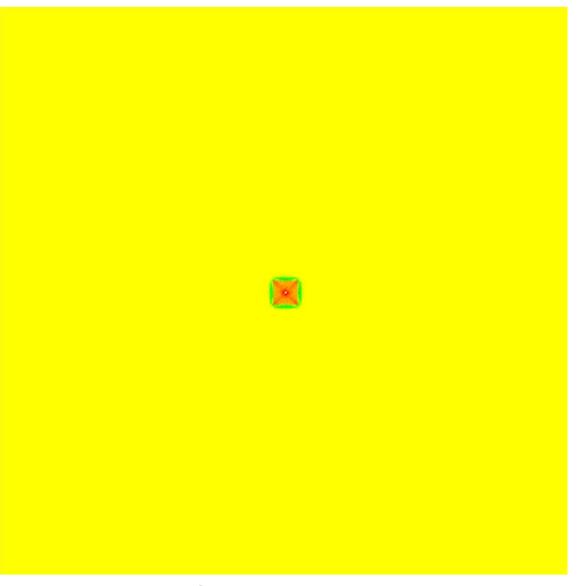
(Ch5) Diffusional Transformations in Solid: Solid \rightarrow Solid

(Ch6) Diffusionless Transformations: Solid \rightarrow Solid



4 Fold Anisotropic Surface Energy/2 Fold Kinetics, Many Seeds

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4 Fold Symmetric Dendrite Array

Contents for today's class

Solidification: Liquid ---- Solid

- < Nucleation >
- Nucleation in Pure Metals
- Homogeneous Nucleation

&

- Heterogeneous Nucleation
 - Nucleation of melting

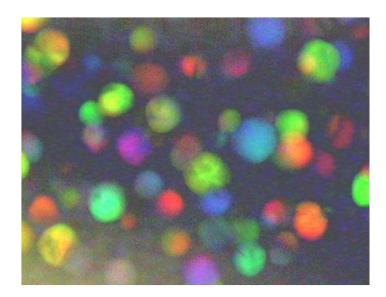
< Growth >

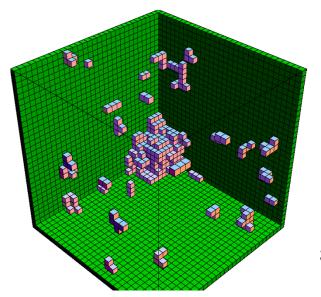
- Equilibrium Shape and Interface Structure on an Atomic Scale
- Growth of a pure solid
- 1) Continuous growth
 - : Atomically rough or diffuse interface
- 2) Lateral growth
 - : Atomically flat of sharply defined interface
- Heat Flow and Interface Stability

Q: Undercooling of homogenous vs heterogenous nucleation ?

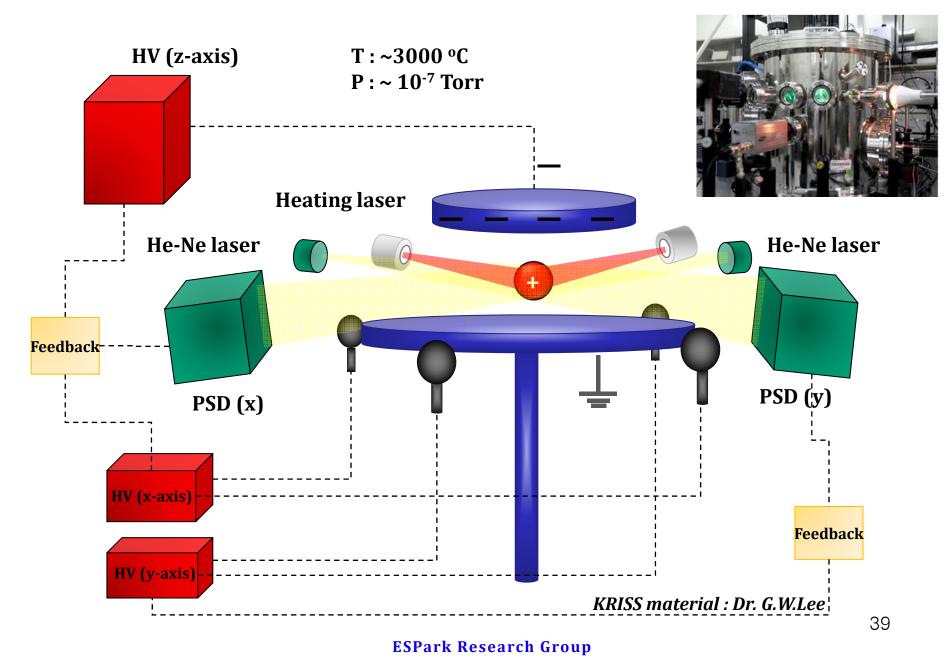
Solidification: Liquid ----- Solid

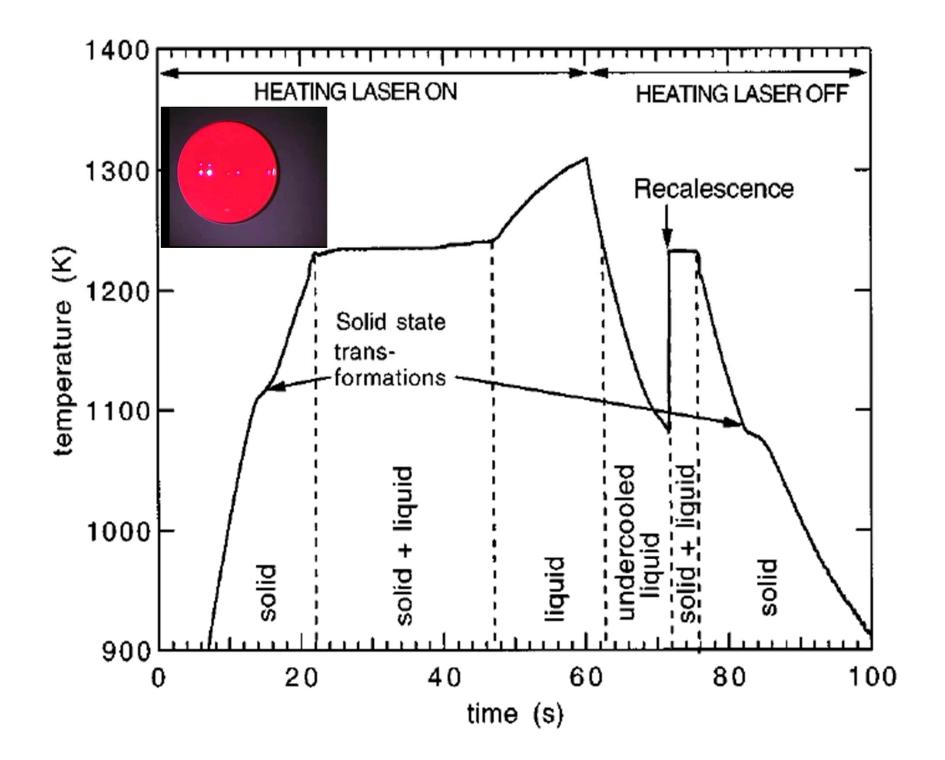
- casting & welding
- single crystal growth
- directional solidification
- rapid solidification
- 4.1. Nucleation in Pure Metals
 - $T_{\rm m}$: $G_{\rm L}$ = $G_{\rm S}$
 - Undercooling (supercooling) for nucleation: 250 K ~ 1 K
 - <Types of nucleation>
 - Homogeneous nucleation Heterogeneous nucleation



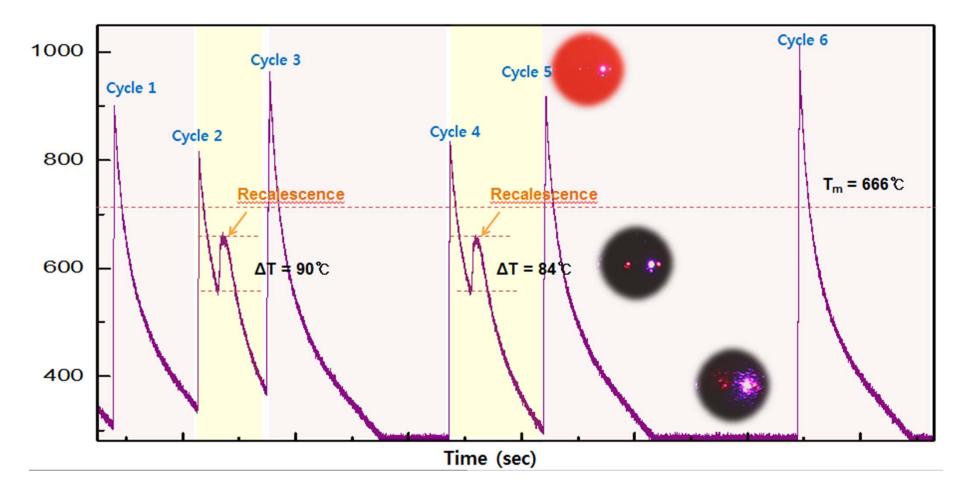


Electrostatic levitation in KRISS





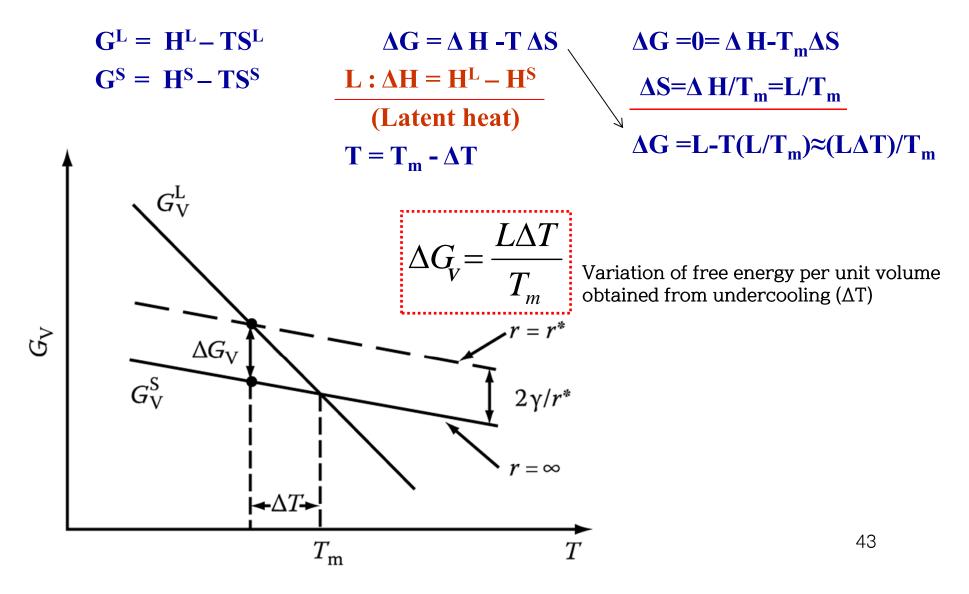
Electrostatic Levitation: cooling curve of Vitreloy 1 system



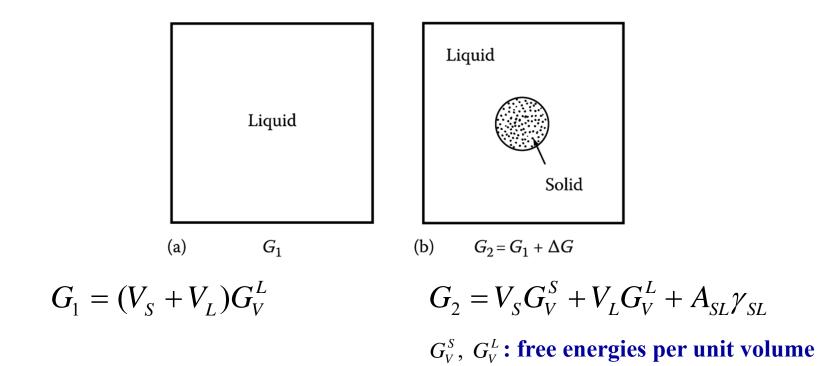
Q: Homogenous nucleation
(a) Driving force for solidification, ΔG_v
(b) Calculation of ΔG_r, r*, ΔG*

4.1.1. Homogeneous Nucleation

Driving force for solidification



4.1.1. Homogeneous Nucleation



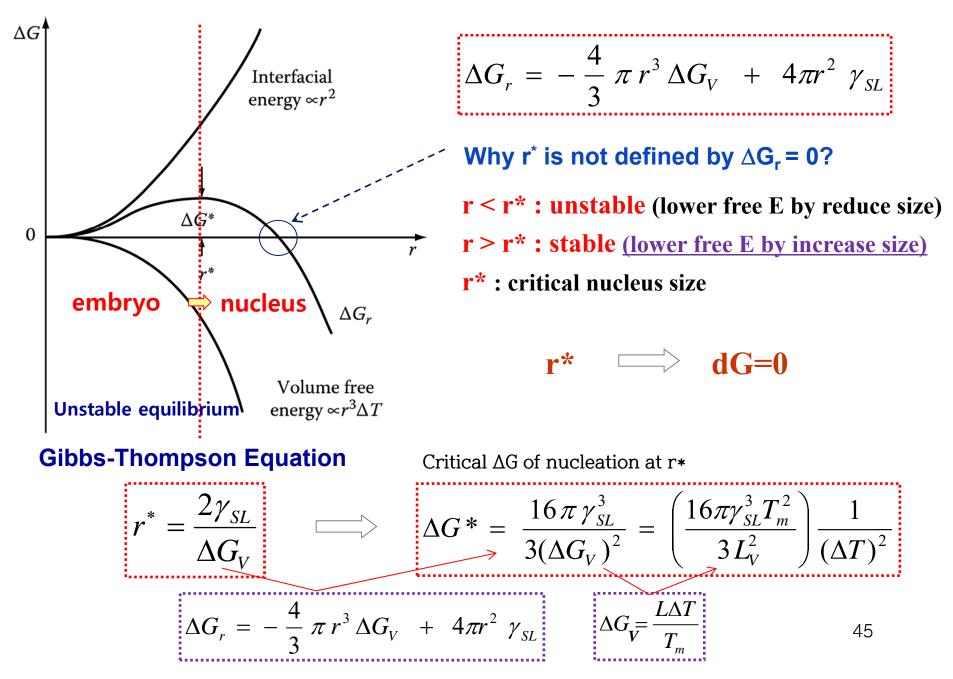
$$\Delta G = G_2 - G_1 = -V_S (G_V^L - G_V^S) + A_{SL} \gamma_{SL}$$

for spherical nuclei (isotropic) of radius : r

$$\Delta G_r = -\frac{4}{3} \pi r^3 \Delta G_V + 4\pi r^2 \gamma_{SL}$$

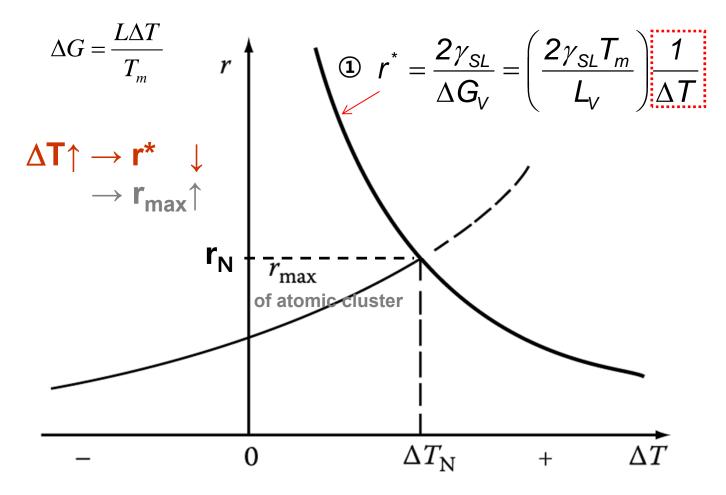
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Calculation of critical radius, r*



Q: How do we define ΔT_N ?

The creation of a critical nucleus ~ thermally activated process



 ΔT_N is the critical undercooling for homogeneous nucleation.

Fig. 4.5 The variation of r* and r_{max} with undercooling ΔT

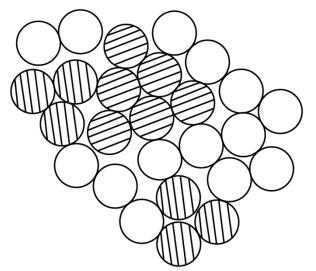
 \rightarrow Condition for nucleation:

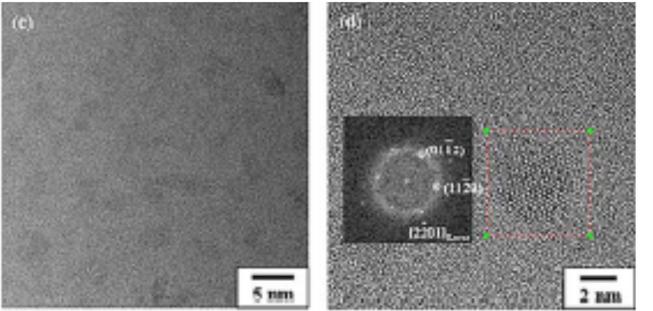
The number of clusters with r^* at T < ΔT_N is negligible.

② Formation of Atomic Cluster

At the $T_{\rm m}$, the liquid phase has <u>a volume 2-4% greater</u> than the solid.

Fig. 4.4 <u>A two-dimensional representation of</u> <u>an instantaneous picture of the liquid structure.</u> <u>Many close-packed crystal-like clusters (shaded)</u> <u>are instantaneously formed.</u>



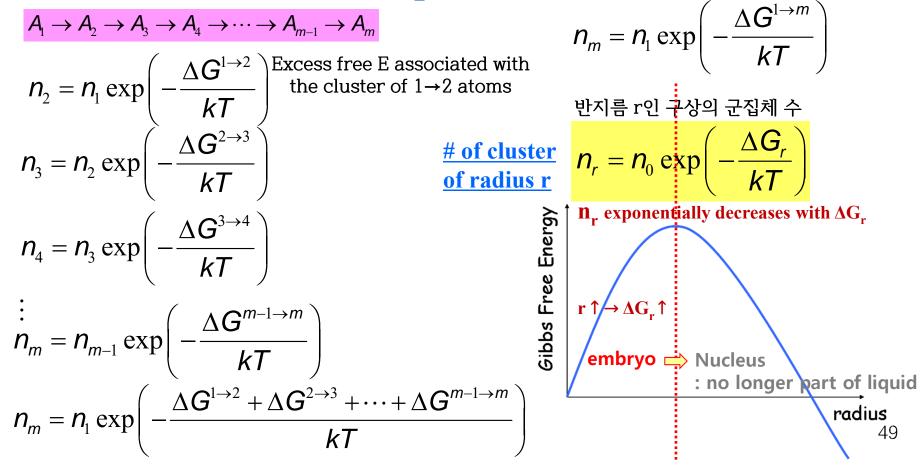


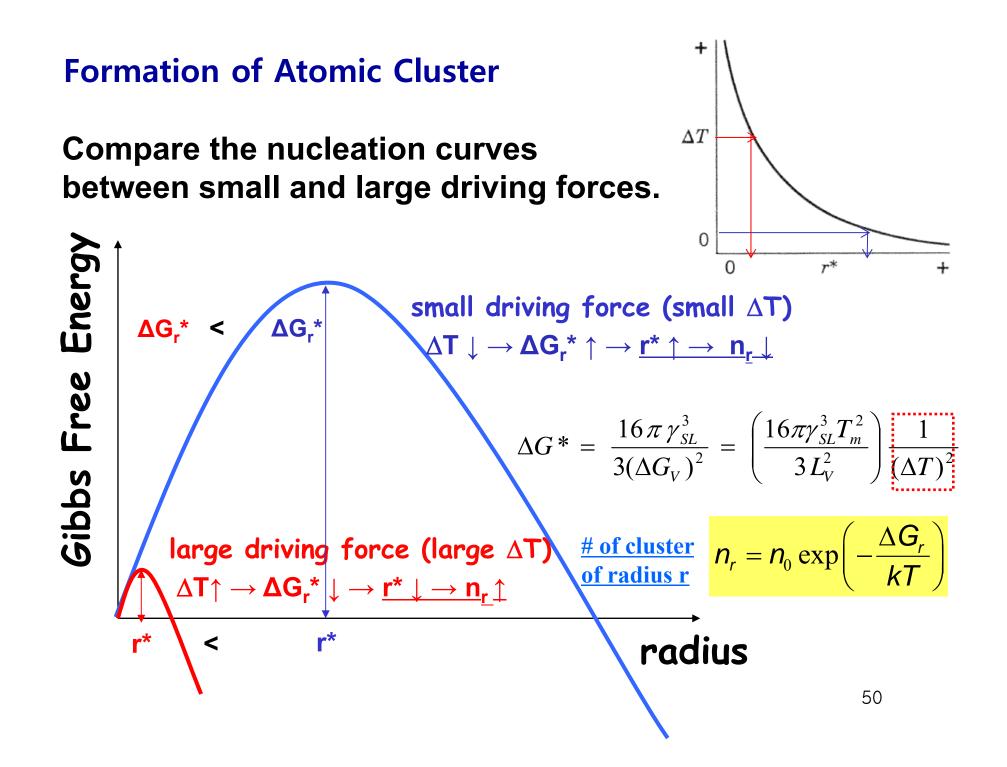
Formation of Atomic Cluster

When the free energy of the atomic cluster with radius r is by

$$\Delta G_r = -\frac{4}{3}\pi r^3 \Delta G_V + 4\pi r^2 \gamma_{SL}$$

how many atomic clusters of radius r would exist in the presence of the total number of atoms, n_0 ?





Formation of Atomic Cluster

 n_0 : total # of atoms.

 ΔG_r : excess free energy associated with the cluster

k : Boltzmann's constant

<u># of cluster of radius r</u>

$$\boldsymbol{n}_r = \boldsymbol{n}_0 \exp\left(-\frac{\Delta \boldsymbol{G}_r}{\boldsymbol{k}T}\right)$$

- holds for $T > T_m / T < T_m$ and $r \le r^*$ Apply for all $r / r \le r^*$ ($\because r > r^*$: no longer part of the liquid) - n_r exponentially decreases with ΔG_r

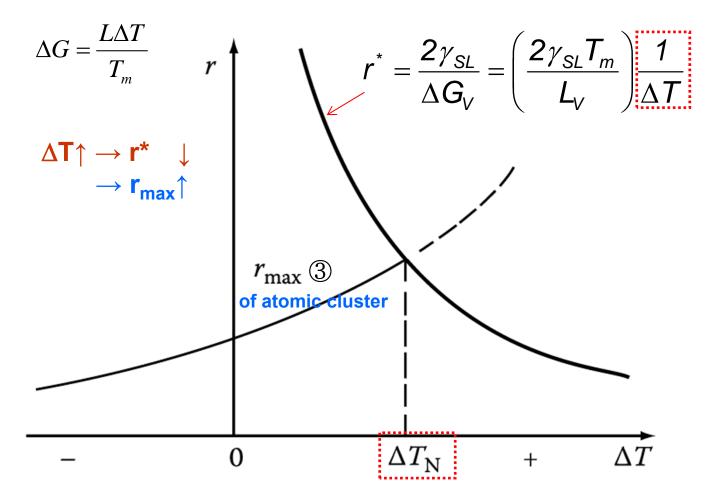
Ex. 1 mm³ of copper <u>at its melting point (n₀: 10²⁰ atoms)</u>

 $r \downarrow \rightarrow n_r \uparrow \rightarrow \sim 10^{14}$ clusters of 0.3 nm radius (i.e. ~ 10 atoms)

 $r \uparrow \rightarrow n_r \downarrow \rightarrow \sim 10$ clusters of 0.6 nm radius (i.e. ~ 60 atoms)

→ effectively a maximum cluster size, ~ 100 atoms ~ 10^{-8} clusters mm⁻³ or <u>1 cluster in ~ 10^7 mm³</u>

The creation of a critical nucleus ~ thermally activated process



 ΔT_N is the critical undercooling for homogeneous nucleation. Fig. 4.5 The variation of r* and r_{max} with undercooling ΔT The number of clusters with r* at $\Delta T < \Delta T_N$ is negligible.

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4.1.2. The homogeneous nucleation rate - kinetics

How fast solid nuclei will appear in the liquid at a given undercooling?

C₀ : atoms/unit volume

 C^* : # of clusters with size of C^* (critical size) 임계핵 크기의 cluster 수

$$C^* = C_0 \exp(-\frac{\Delta G_{\text{hom}}^*}{kT})$$
 clusters / m³

The addition of one more atom to each of these clusters will convert theminto stable nuclei.한 개 원자 추가로 확산시 핵생성

Homogeneous Nucleation rate $N_{\text{hom}} = f_0 C_o \exp(-\frac{\Delta G_{\text{hom}}^*}{kT})$ nuclei / m³·s

 $f_{o} \sim 10^{11} \text{ s}^{-1}: \text{ frequency } \propto \text{ vibration frequency energy} \\ \text{ of diffusion in liquid surface area (const.)} \quad \Delta G * = \left(\frac{16\pi\gamma_{SL}^{3}T_{m}^{2}}{3L_{V}^{2}}\right) \frac{1}{(\Delta T)^{2}} \\ C_{o} \sim \text{typically } 10^{29} \text{ atoms/m}^{3} \\ N_{\text{hom}} \approx 1 \text{ cm}^{-3} \text{ s}^{-1} \text{ when } \Delta \text{G}^{*} \sim 78 \text{ kT}$ 53

Reasonable nucleation rate

4.1.2. The homogeneous nucleation rate - kinetics

$$N_{\text{hom}} \approx f_0 C_o \exp\{-\frac{A}{(\Delta T)^2}\}$$

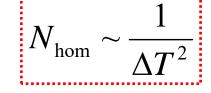
 ΔT

where
$$A = \frac{16\pi\gamma_{SL}^3 T_m^2}{3L_V^2 kT}$$

A = relatively insensitive to Temp.

How do we define ΔT_N ?

 $\Delta T_{\rm N}$



<u>Changes by orders of magnitude</u> <u>from essentially zero to very high</u> <u>values over a very narrow</u> <u>temperature range</u>



- critical supersaturation ratio
- critical driving force
- critical supercooling
- \rightarrow for most metals, $\Delta T_N \sim 0.2 T_m$ (i.e. ~ 200 K)

Fig. 4.6 The homogeneous nucleation rate as a function of undercooling $\Delta T. \Delta T_N$ is the critical undercooling for homogeneous nucleation. 54



0

* Copper Homogeneous nucleation

 $\Delta T = 230 \text{ K} \rightarrow r* \sim 10^{-7} \text{ cm} < 4 * \text{(Diameter of Cu atom)}$

If nucleus is spherical shape,

<u>V = $4.2 \times 10^{-21} \text{ cm}^3 \sim 360 \text{ atoms}$ (:: one Cu atom $1.16 \times 10^{-23} \text{ cm}^3$)</u>

"Typically in case of metal" $\Delta T * \sim 0.2 T_E / \sigma_{SL} \sim 0.4 L$ r* (critical nucleus for homogeneous nucleation) of metal ~ 200 atoms

But, if cluster radius ~ (only 4 * atom diameter),

"no spherical shape"

(large deviation from spherical shape) \rightarrow

→ Possible structure for the critical nucleus of Cu

: bounded only by {111} and {100} plane

- σ_{SL} may very with the crystallographic nature of the surface.
- The faces of this crystal are close to their critical size for 2D nucleation at the critical temp for the nucleus as a whole.

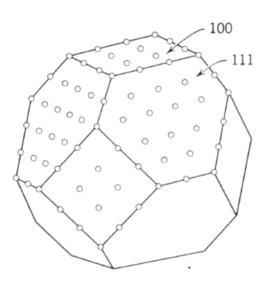


Fig. 3.11. Possible structure for the critical nucleus. (From B. Chalmers, *Physical Metallurgy*, John Wiley and Sons, New York, 1959, p. 246.)

Real behavior of nucleation: metal $\Delta T_{bulk} < \Delta T_{small drop}$

Under suitable conditions, liquid nickel can be undercooled (or supercooled) to 250 K below T_m (1453°C) and held there indefinitely without any transformation occurring.

Normally undercooling as large as 250 K are not observed. The nucleation of solid at undercooling of only ~ 1 K is common.

The formation of a nucleus of critical size can be <u>catalyzed by a suitable</u> surface in contact with the liquid. \rightarrow "Heterogeneous Nucleation"

Ex) _	liquid	– or	Solid thin film (such as oxide)
	container	U	liquid

Why this happens? What is the underlying physics? Which equation should we examine?

$$\Delta G^* = \frac{16\pi \gamma_{SL}^3}{3(\Delta G_V)^2} = \left(\frac{16\pi \gamma_{SL}^3 T_m^2}{3 L_V^2}\right) \frac{1}{(\Delta T)^2} \qquad N_1$$

$$N_{\rm hom} = f_0 C_o \exp(-\frac{\Delta G_{\rm hom}^*}{kT})$$
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